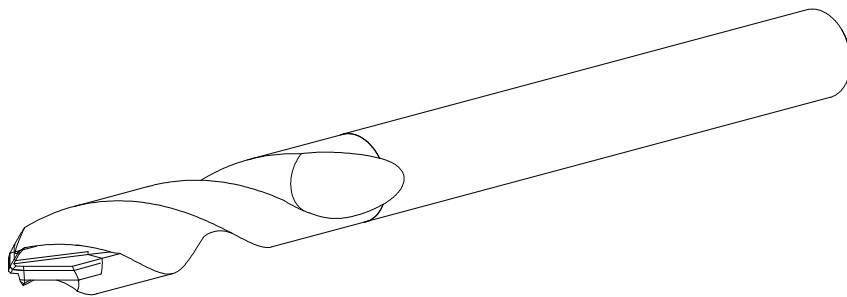


PCD Wafer Drill (mm)

Cutting Diameter (+0.015)	Shank Diameter (h6)	LOC (+1.0)	OAL (+1.5)	cat#
4.19	6.00	28	70	TSDR042006M
4.85	6.00	28	70	TSDR049006M
6.375	8.00	32	75	TSDR064008M
7.938	8.00	32	75	TSDR079008M
10.00	10.00	40	84	TSDR100010M
12.00	12.00	45	89	TSDR120012M



PCD SPIRAL WAFER DRILL			
Materials:	Carbide ; PCD	SCALE: NTS	<p>This drawing is The property of TELCON DIAMOND And may only be Copied or passed To a third party With our permission.</p>
CAT. NO.	By Table		
		Unless specified Tolerances are in Accordance with: DIN ISO 2768-m	